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www.vishay.com

Vishay Semiconductors

MTP PressFit Power Module Three Phase Bridge, 45 A to 100 A



| PRODUCT SUMMARY | | | | | |
|-----------------|--------------------|--|--|--|--|
| Ι _Ο | 45 A to 100 A | | | | |
| V_{RRM} | 1600 V | | | | |
| Package | MTP PressFit | | | | |
| Circuit | Three phase bridge | | | | |

FEATURES

- Low V_F
- · Low profile package
- · Direct mounting to heatsink
- · PressFit pins technology
- · Low junction to case thermal resistance
- 3500 V_{RMS} insulation voltage
- · Designed and qualified for industrial level
- PressFit pins locking technology. Patent # US.263.820 B2
- UL approved file E78996
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

APPLICATIONS

- · Power conversion machines
- Welding
- UPS
- SMPS
- Motor drives
- General purpose and heavy duty application

DESCRIPTION

The new MTP module is easy to use thanks to solder less method for contacting PressFit pins to the PCB. The low profile package has been specifically conceived to maximize space saving and optimize the electrical layout of the application specific power supplies.

| MAJOR F | MAJOR RATINGS AND CHARACTERISTICS | | | | | | |
|-------------------|-----------------------------------|----------------|----------------|-----------------|------------------|--|--|
| SYMBOL | CHARACTERISTICS | VALUES 40MT | VALUES 70MT | VALUES 100MT | UNITS | | |
| | | 45 | 75 | 100 | А | | |
| I _O | T _C | 100 | 80 | 80 | °C | | |
| | 50 Hz | 270 | 380 | 450 | ^ | | |
| I _{FSM} | 60 Hz | 280 | 398 | 470 | Α | | |
| l ² t | 50 Hz | 365 | 724 | 1013 | A2a | | |
| 1-1 | 60 Hz | 325 | 660 | 920 | A ² s | | |
| I ² √t | | 3650 | 7240 | 10 130 | A²√s | | |
| V _{RRM} | | <u>.</u> | V | | | | |
| T _{Stg} | Denge | | °C | | | | |
| TJ | Range | | -40 to +150 | |] | | |

PATENT(S): www.vishay.com/patents

This Vishay product is protected by one or more United States and International patents.



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ELECTRICAL SPECIFICATIONS

| VOLTAGE RATINGS | | | | | | | |
|--|--------------------------------------|---|--|--|--|--|--|
| TYPE NUMBER | VOLTAGE CODE REVERSE VOLTAGE V | V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V | V _{RSM} , MAXIMUM NON-REPETITIVE PEAK V | I _{RRM} MAXIMUM AT T _J = 150 °C mA | | | |
| VS-40MT160P-P, VS-70MT160P-P, VS-100MT160P-P | 160 | 1600 | 1700 | 5 | | | |

| FORWARD CONDUCTION | | | | | | | | |
|--|--------------------|----------------------|--|---------|---------------|----------------|-----------------|-------------------|
| PARAMETER | SYMBOL | | TEST CONDI | TIONS | VALUE 40MT | VALUES 70MT | VALUES 100MT | UNITS |
| Maximum DC output current at case | | 100° reet to | and esting angle | | 45 | 75 | 100 | Α |
| temperature | l _o | 120 rect. to | conduction angle | | 100 | 80 | 80 | °C |
| | | t = 10 ms | No voltage | | 270 | 380 | 450 | |
| Maximum peak, one cycle forward, non-repetitive on | _ | t = 8.3 ms | reapplied | | 280 | 398 | 470 | |
| state surge current | I _{FSM} | t = 10 ms | 100 % V _{RRM} reapplied | Initial | 225 | 320 | 380 | A |
| | | t = 8.3 ms | | | 240 | 335 | 400 | |
| | | t = 10 ms No voltage | $T_J = T_J$ maximum | 365 | 724 | 1013 | | |
| Maximum I ² t for fusing | l ² t | t = 8.3 ms | reapplied | | 325 | 660 | 920 | A ² s |
| Maximum i-t for fusing | 1-1 | t = 10 ms | 100 % V _{RRM} | | 253 | 512 | 600 | A-5 |
| | | t = 8.3 ms reapplied | 240 | 467 | 665 | | | |
| Maximum I ² √t for fusing | I ² √t | t = 0.1 ms to | t = 0.1 ms to 10 ms, no voltage reapplied | | | 7240 | 10 130 | A ² √s |
| Value of threshold voltage | V _{F(TO)} | T mavimum | T _J maximum | | | 0.82 | 0.75 | V |
| Slope resistance | r _t | ı j maximum | | | | 9.5 | 8.1 | mΩ |
| Maximum forward voltage drop | V _{FM} | | $T_J = 25$ °C; $t_p = 400 \mu s$ single junction (40MT, $I_{pk} = 40 A$) (70MT, $I_{pk} = 70 A$) (100MT, $I_{pk} = 100 A$ | | | 1.45 | 1.51 | V |

| INSULATION TABLE | | | | | | | |
|------------------------|------------------|--|---------------|------|-------|-------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | 40 M T | 70MT | 100MT | UNITS | |
| RMS insulation voltage | V _{INS} | T _J = 25 °C, all terminal shorted, f = 50 Hz, t = 1 s | 3500 V | | V | | |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | | |
|---|-------------------|--|-------------|-------------|-------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | 40MT | 70MT | 100MT | UNITS |
| Maximum junction operating temperature range | TJ | | -40 to +150 | | °C | |
| Maximum storage temperature range | T _{Stg} | | | -40 to +125 | | |
| | | DC operation per module | 0.27 | 0.23 | 0.19 | |
| Maximum thermal resistance, | R _{thJC} | DC operation per junction | 1.6 | 1.38 | 1.14 | |
| junction to case | | 120° rect. condunction angle per module | 0.38 | 0.29 | 0.22 | |
| | | 120° rect. condunction angle per junction | 2.25 | 1.76 | 1.29 | K/W |
| Maximum thermal resistance, case to heatsink per module | R _{thCS} | Mounting surface smooth, flat and greased heatsink compound thermal conductivity = 0.42 W/mK | 0.1 | | | |
| Mounting torque to heatsink ± 10 % | | A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Lubricated threads 4 65 | | 4 | | Nm |
| Approximate weight | | | | | g | |

Creepage distance

VS-40MT160P-P, VS-70MT160P-P, VS-100MT160P-P

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| CLEARANCE AND CREEPAGE DISTANCES | | | | | | |
|----------------------------------|--|--------------|-------|--|--|--|
| PARAMETER | TEST CONDITIONS | MTP PressFit | UNITS | | | |
| Clearance | External shortest distances in air between terminals which are not internally short circuited together | 10.2 | | | | |
| | | | mm | | | |

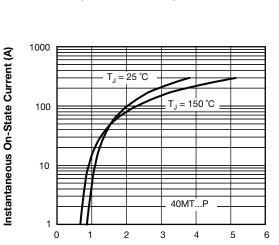
Shortest distance along external surface of the insulating material

between terminals which are not internally short circuited together

| Maximum Allowable Case Temperature (°C) | 60 (|) - | | 20 3 utput Cu | | 40 | 50 |
|---|------|-----|---------------------|----------------------|---------|----------|----------|
| Ē | 80 | | | | | | |
| ₩ | 90 | | | | | | - |
| wab | 100 | | | | | \vdash | \dashv |
| S C | 110 | | | 120 (Rec | t) — | | \dashv |
| ase | 120 | | | | | | \dashv |
| Temp | 130 | | | | | | \dashv |
| erat | 140 | | | | | | \dashv |
| nre (° | 150 | | — R _{thJC} | $(DC) = 0.2^{\circ}$ | 7 K/W — | | \dashv |
| ပ | 160 | | 40MT. | P | ı | | \neg |

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Fig. 1 - Current Rating Characteristics



Instantaneous On-State Voltage (V)
Fig. 2 - On-State Voltage Drop Characteristics

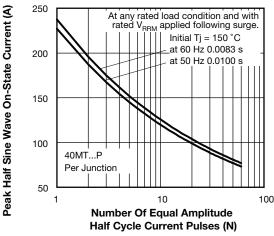


Fig. 3 - Maximum Non-Repetitive Surge Current

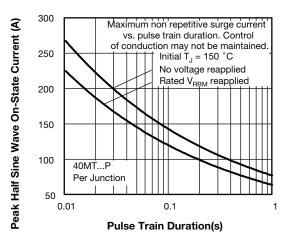


Fig. 4 - Maximum Non-Repetitive Surge Current

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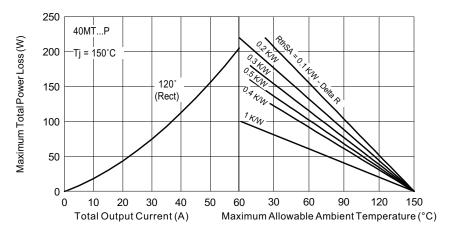


Fig. 5 - Current Rating Nomogram (1 Module Per Heatsink)

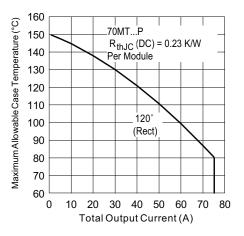


Fig. 6 - Current Rating Characteristics

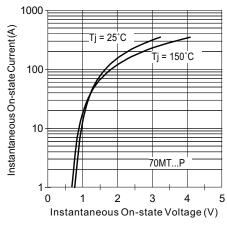


Fig. 7 - On-State Voltage Drop Characteristics

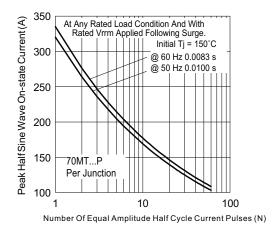


Fig. 8 - Maximum Non-Repetitive Surge Current

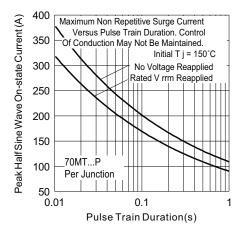


Fig. 9 - Maximum Non-Repetitive Surge Current

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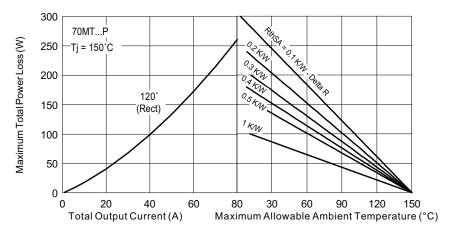


Fig. 10 - Current Rating Nomogram (1 Module Per Heatsink)

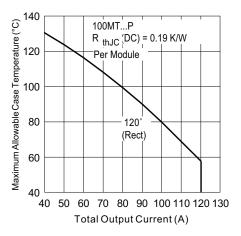


Fig. 11 - Current Rating Characteristics

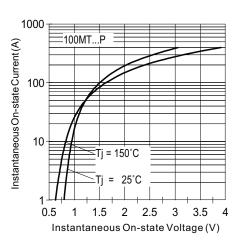


Fig. 12 - On-State Voltage Drop Characteristics

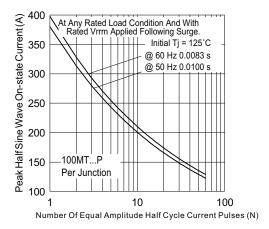


Fig. 13 - Maximum Non-Repetitive Surge Current

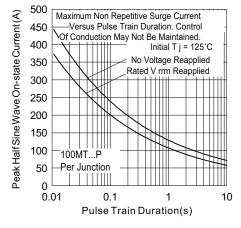


Fig. 14 - Maximum Non-Repetitive Surge Current

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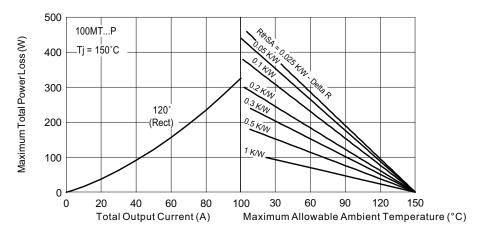


Fig. 15 - Current Rating Nomogram (1 Module Per Heatsink)

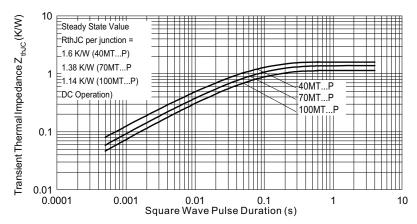


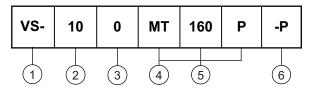
Fig. 16 - Thermal Impedance Z_{thJC} Characteristics

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ORDERING INFORMATION TABLE



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1 - Vishay Semiconductors product

4 = 45 A 7 = 75 A 10 = 100 A

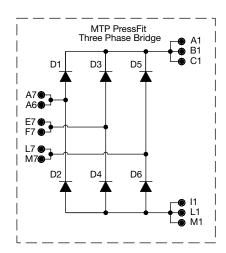
- Circuit configuration code: 0 = Three Phase Bridge

4 - Package indicator

Voltage code x 10 = V_{RRM} (see Voltage Ratings table)

6 - Pinout code (PressFit pins)

CIRCUIT CONFIGURATION



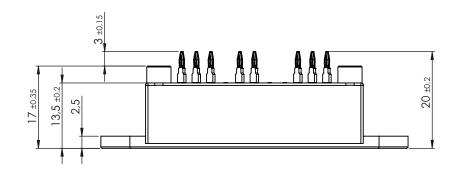
| LINKS TO RELATED DOCUMENTS | | | | | |
|----------------------------|--------------------------|--|--|--|--|
| Dimensions | www.vishay.com/doc?95595 | | | | |

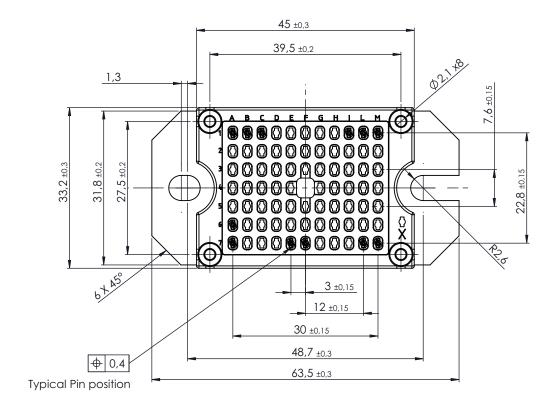


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MTP Three Phase PressFit

DIMENSIONS in millimeters







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